



Product Change Notification

Change Notification #: 116155 - 00
Change Title: Intel® Ethernet Network Connection
OCP X557-T2,
Product Code: X557T2OCPG1P5, MM#950179,
PCN 116155-00, Product Design,
Resistor update
Date of Publication: March 14, 2018

Key Characteristics of the Change:

Product Design,

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 29, 2018
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Description of Change to the Customer:

The Intel® Ethernet Network Connection OCP X557-T2 listed in the Product Affected table will undergo the following change:

- Resistors were changed in the onboard voltage level converter circuit to reduce voltage regulator (VR) noise and increase PHY FW NVM Verification reliability.

As a result of these changes, the PBA (printed board assembly) and TA (top assembly) numbers will roll as noted in the affected products table within this PCN. If the PBA/TA numbers are printed on any product or box labels, those will show the PBA/TA dash roll as well.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
X557T2OCPG1P5	950179	J44660-002	H87480-008	J44660-003	H87480-009

PCN Revision History:

Date of Revision: March 14, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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